ATXAIG-H13

Request Samples



Check Inventory (>)



2.0 x 1.6 x 0.8 mm **RoHS/RoHS II Compliant** MSL Level = 1

Features

- AEC-Q200 Qualified
- TS16949 Production Line Certified
- PPAP Available Upon Request
- Both continuous & fixed Vdd options available

Applications

- Cellular and cordless phones
- Standard oscillator for exact equipment
- Consumer electronics
- Industrial control & automation
- Mobile communication

Electrical Specifications [Note 1]

Parameters	Min.	Тур.	Max.	Units	Notes
Frequency Range	8.0		70	MHz	
Operating Temperature	-40		+85	°C	See Options (Table 1)
Storage Temperature	-55		+125	°C	
Frequency Stability $\Delta f/f_o$ vs:					
	rance -1.0		+1.0		Reference to f _o , at 25°C±2°C, Pre-reflow
Tole	rance -2.0		+2.0		Reference to f _o , at 25°C ±2°C, 24 hours after reflow, two times
Temper	rature -2.5		+2.5	ppm	See Options (Table 1) Reference to f _o , at 25°C ±2°C
Supply Voltage Cl	hange -0.3		+0.3		Vdd ± 5%
Load Ci			+0.2		
Aging	-1.0		+1.0		First year @+25°C±2°C
	+3.135	+3.3	+3.465		Option E
	+2.85	+3.0	+3.15		Option A
Supply Voltage (Vdd)	+2.66	+2.8	+2.94	V	Option B
Supply voltage (vdd)	+2.375	+2.5	+2.625	v	Option C
	+1.71	+1.8	+1.89		Option D
	+1.68		+3.63		Option F
Supply Current (Idd)			10	mA	
Start-up Time			2	ms	
Rise and Fall Time (Tr/Tf) @10%Vdd-90%Vdd, 15pF load			5	ns	
Symmetry @ ½ Vdd	45	50	55	%	
Vou	90%Vdd			V	
Output Voltage Vol.			10%Vdd	v	
Output Load			15	pF	CMOS
Output Waveform		CMOS			
Tri-state function [Note 2]		"1" (VIH≥0.7*Vdd) or Open: Oscillation; "0" (VIL<0.3*Vdd): No Oscillation/Hi Z			

All measurements made at 25°C ±2°C, nominal Vdd, unless otherwise specified

Do not leave pin 1 $(\overline{\text{INH}})$ floating. If pin 1 $(\overline{\text{INH}})$ is not utilized for toggling, it must be tied to Vdd (logic 1). Note 2:



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Part Identification

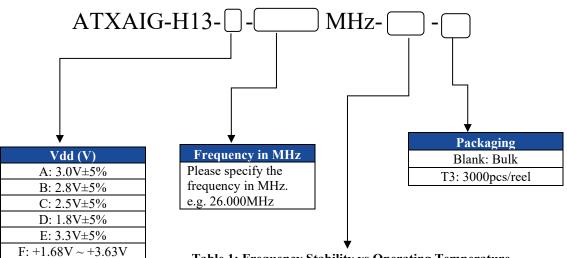


Table 1: Frequency Stability vs Operating Temperature

Tubic It I requeste	y stability vs operating reinperature					
	±2.5ppm	±3.0ppm	±4.0ppm	±5.0ppm		
$0^{\circ}\text{C} \sim +70^{\circ}\text{C}$	A25	A30	A40	A50		
-10°C ~ +60°C	B25	B30	B40	B50		
-20°C ~ +70°C	C25	C30	C40	C50		
-30°C ~ +75°C	D25	D30	D40	D50		
-30°C ~ +85°C	E25	E30	E40	E50		
-40°C ~ +85°C	F25	F30	F40	F50		



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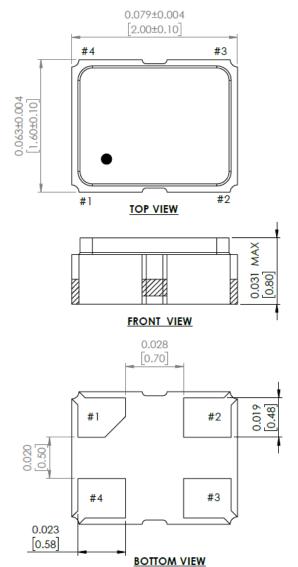


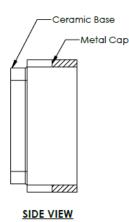
Check Inventory

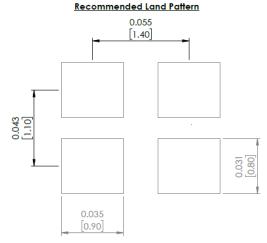


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Mechanical Dimensions







Pin #	Function
1	ĪNĦ
2	GND
3	Output
4	Vdd

INH Function				
#1 #3 (Output)				
Open	Active			
"H" Level	Active			
"L" Level	High Z (No Oscillation)			

- -Do not leave Pin 1 (INH) floating
- -If Pin 1 (INH) is not utilized for toggling, it must be tied to Vdd (logic 1)

Note 4:

Recommended to use approximately 0.01µF bypass capacitor between PIN 2 and PIN 4

Dimensions: inches (mm)



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Reflow Profile [JDEC J-STD-020]

Tp

 $T_{L^{\prime}}$

Temperature

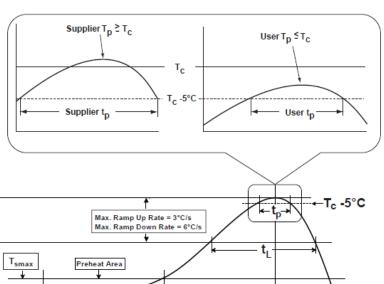


Table 1

SnPb Eutectic Process Classification Temperatures (Tc)				
Package Thickness	Volume mm ³ <350	Volume mm³ ≥350		
<2.5 mm	235 °C	220 °C		
≥2.5 mm	220 °C	220 °C		

Table 2

	Pb-Free Process Classification Temperatures (T _c)					
Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000			
<1.6 mm	260 °C	260 °C	260 °C			
1.6 mm - 2.5 mm	260 °C	250 °C	245 °C			
>2.5 mm	250 °C	245 °C	245 °C			

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Preheat / soak			
Temperature minimum (T _{smin})	100°C	150°C	
Temperature maximum (T _{smax})	150°C	200°C	
Time $(T_{smin} \text{ to } T_{smax}) (t_s)$	60 - 120 sec.	60 - 120 sec.	
Average ramp-up rate $(T_{smax} \text{ to } T_P)$	3°C/sec. max	3°C/sec. max	
Liquidous temperature (T _L)	183°C	217°C	
Time at liquidous (t _L)	60 - 150 sec.	60 - 150 sec.	
Peak package body temperature (T _P)*	see Table 1	see Table 2	
Time $(t_p)^{**}$ within 5°C of the specified classification temperature (T_C)	20 sec.	30 sec.	
Ramp-down rate (T_p to T_{smax})	6°C/sec. max	6°C/sec. max	
Time 25°C to peak temperature	6 min. max	8 min. max	

^{*}Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.



Time 25°C to Peak

^{**}Tolerance for time at peak profile temperature (tp) is defined as supplier minimum and a user maximum.

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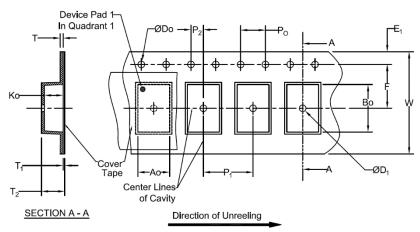
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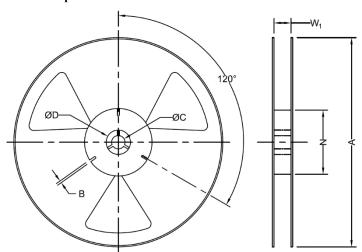
Packaging

T3: 3,000pcs/reel



Tape Specifications (mm) Width Bo D₁ (Min) F E_1 Do Ko Αo 8mm 1.5+0.1/-0.0 1.75±0.1 3.5±0.05 1.0 \mathbf{P}_1 P₂ $P_0 \\$ T (Max) W (Max) Width T₁ (Max) T₂ (Max) 4.0 ± 0.1 2.0 ± 0.05 4.0±0.1 0.6 0.1 2.5 8.3 8mm

*Note: Compliant to EIA-481



Reel Specifications (mm)							
Width	Width Oty/Reel A B C (Min) D N *W ₁						
8mm	3000	178	1.5	13.0+0.5/-0.2	20.2	50	8.4+1.5/-0.0

*Note: Measured at Hub

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